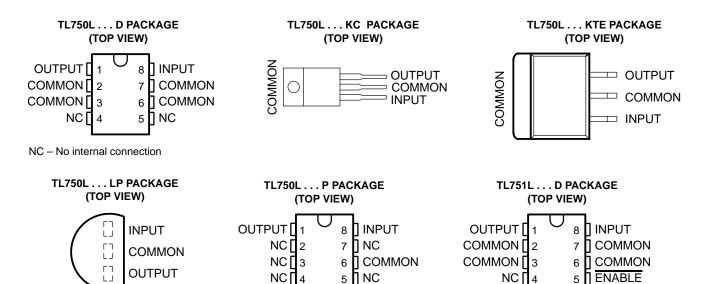
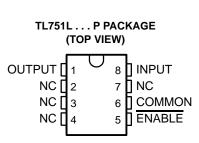
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- Very Low Dropout Voltage, Less Than 0.6 V at 150 mA
- Very Low Quiescent Current
- TTL- and CMOS-Compatible Enable on TL751L Series
- 60-V Load-Dump Protection

- Reverse Transient Protection Down to –50 V
- Internal Thermal-Overload Protection
- Overvoltage Protection
- Internal Overcurrent-Limiting Circuitry
- Less Than 500-μA Disable (TL751L Series)

NC - No internal connection





NC - No internal connection

NC - No internal connection

description/ordering information

TO-226AA

The TL750L and TL751L series of fixed-output voltage regulators offers 5-V, 8-V, 10-V, and 12-V options. The TL751L series also has an enable (ENABLE) input. When ENABLE is high, the regulator output is placed in the high-impedance state. This gives the designer complete control over power up, power down, or emergency shutdown.

The TL750L and TL751L series are low-dropout positive-voltage regulators specifically designed for battery-powered systems. These devices incorporate overvoltage and current-limiting protection circuitry, along with internal reverse-battery protection circuitry to protect the devices and the regulated system. The series is fully protected against 60-V load-dump and reverse-battery conditions. Extremely low quiescent current during full-load conditions makes these devices ideal for standby power systems.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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description/ordering information (continued)

ORDERING INFORMATION

ТЈ	V _O TYP AT 25°C	PACKAG	ΕŤ	ORDERABLE PART NUMBER	TOP-SIDE MARKING			
		POWER-FLEX (KTE)	Reel of 2000	TL750L05CKTER	TL750L05C			
			Tube of 75	TL750L05CD	50L05C			
		SOIC (D)	Reel of 2500	TL750L05CDR	50L05C			
	5 V	301C (D)	Tube of 75	TL751L05CD	541.05C			
	5 V		Reel of 2500	TL751L05CDR	TL750L05C - 50L05C - 51L05C - 750L05C - TL750L05C - 50L08C - 750L08C - TL751L10C - 50L10C - 51L10C			
		TO-92 (LP)	Bulk of 1000	TL750L05CLP	750L05C			
		10-92 (LP)	Reel of 2000	TL750L05CLPR	750L05C			
		TO-220 (KC)	Tube of 50	TL750L05CKC	TL750L05C			
	8 V	SOIC (D)	Tube of 75	TL750L08CD	501.090			
0°C to 125°C		301C (D)	Reel of 2500	TL750L08CDR	50L06C			
		TO-92 (LP)	(LP) Bulk of 1000 TL750L08CLP	750L08C				
		PDIP (P)	Tube of 50	TL751L10CP	TL751L10C			
			Tube of 75	TL750L10CD	501.100			
		SOIC (D)	Reel of 2500	TL750L10CDR	302100			
	10 V	301C (D)	Tube of 75	TL751L10CD	541 10C			
			Reel of 2500	TL751L10CDR	51L10C			
		TO-92 (LP)	Bulk of 1000	TL750L10CLP	750L10C			
		10-92 (LF)	Reel of 2000	TL750L10CLPR	730L10C			
			Tube of 75	TL750L12CD	50L12C			
		SOIC (D)	Reel of 2500	TL750L12CDR	JUL 120			
	12 V	3010 (D)	Tube of 75	TL751L12CD	51L12C			
			Reel of 2500	TL751L12CDR	311120			
		TO-92 (LP)	TO-92 (LP) Bulk of 1000		750L12C			

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available www.ti.com/sc/package.

DEVICE COMPONENT COUNT					
Transistors 20					
JFETs	2				
Diodes	5				
Resistors	16				

TL750L, TL751L SERIES LOW-DROPOUT VOLTAGE REGULATORS

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absolute maximum ratings over operating junction temperature range (unless otherwise noted)

Continuous input voltage	26 V
Transient input voltage, T _A = 25°C (see Note 1)	
Continuous reverse input voltage	
Transient reverse input voltage, t ≤ 100 ms	–50 V
Package thermal impedance, θ _{JA} (see Notes 2 and 3): D package	97°C/W
(see Notes 2 and 4): KC package	25°C/W
(see Notes 2 and 4): KTE package	23°C/W
(see Notes 2 and 3): LP package	156°C/W
(see Notes 2 and 3): P package	85°C/W
Operating virtual junction temperature, T _J	150°C
Lead temperature 1,6 mm (1/16 inch) for 10 seconds	260 mA
Storage temperature range, T _{stq}	−65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The transient input voltage rating applies to the waveform shown in Figure 1.
 - 2. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.
 - 4. The package thermal impedance is calculated in accordance with JESD 51-5.

recommended operating conditions over recommended operating junction temperature range (unless otherwise noted)

				MIN	MAX	UNITS
			TL75xL05	6	26	
V _I Input voltage			TL75xL08	9	26	V
			TL75xL10	11	26	V
			TL75xL12	13	26	
VIH	High-level ENABLE input voltage		TL751Lxx	2	15	V
\ \ +			TL751Lxx	-0.3	0.8	V
V _{IL} ‡	Low-level ENABLE input voltage	$T_J = 0$ °C to 125°C	TL751Lxx	-0.15	0.8	V
lo	Output current range		TL75xLxx	0	150	mA
TJ	Operating virtual junction temperature		TL75xLxxC	0	125	°C

[‡] The algebraic convention, in which the least positive (most negative) value is designated minimum, is used in this data sheet for ENABLE voltage levels and temperature only.



TL750L, TL751L SERIES LOW-DROPOUT VOLTAGE REGULATORS

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electrical characteristics, $V_I = 14 \text{ V}$, $I_O = 10 \text{ mA}$, $T_J = 25^{\circ}\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]			TL750L05 TL751L05			UNIT
				MIN	TYP	MAX	
Output voltage	VI - 6 V to 26 V	I _O = 0 to 150 mA	T _J = 25°C	4.80	5	5.2	V
Output voitage	$V_{I} = 6 \text{ V to } 26 \text{ V},$	IQ = 0 to 150 IIIA	T _J = 0°C to 125°C	4.75		5.25	V
Input regulation voltage	V _I = 9 V to 16 V				5	10	mV
Input regulation voltage	V _I = 6 V to 26 V				6	30	IIIV
Ripple rejection	V _I = 8 V to 18 V,	f = 120 Hz		60	65		dB
Output regulation voltage	$I_O = 5 \text{ mA to } 150 \text{ mA}$				20	50	mV
Dranaut valtaga	I _O = 10 mA					0.2	V
Dropout voltage	I _O = 150 mA					0.6	v
Output noise voltage	f = 10 Hz to 100 kHz				500		μV
Input bias current	I _O = 150 mA				10	12	
	V _I = 6 V to 26 V,	$I_{O} = 10 \text{ mA},$	$T_J = 0$ °C to 125°C		1	2	mA
	ENABLE > 2 V					0.5	

 $[\]dot{T}$ Pulse-testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.1-μF capacitor across the input and a 10-μF capacitor, with equivalent series resistance of less than 0.4 Ω , across the output.

electrical characteristics, $V_I = 14 \text{ V}$, $I_O = 10 \text{ mA}$, $T_J = 25^{\circ}\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]			TL750L08 TL751L08			UNIT	
				MIN	TYP	MAX		
Output voltage	V _I = 9 V to 26 V,	I _O = 0 to 150 mA	T _J = 25°C	7.68	8	8.32	٧	
Output voltage	V = 9 V 10 26 V,	IQ = 0 to 150 IIIA	T _J = 0°C to 125°C	7.6		8.4	V	
Input regulation voltage	V _I = 10 V to 17 V				10	20	mV	
Input regulation voltage	V _I = 9 V to 26 V				25	50	IIIV	
Ripple rejection	$V_{I} = 11 \text{ V to } 21 \text{ V},$	f = 120 Hz		60	65		dB	
Output regulation voltage	$I_O = 5 \text{ mA to } 150 \text{ mA}$				40	80	mV	
Dropout voltage	I _O = 10 mA					0.2	V	
Dropout voltage	I _O = 150 mA					0.6	V	
Output noise voltage	f = 10 Hz to 100 kHz				500		μV	
	I _O = 150 mA				10	12		
Input bias current	V _I = 9 V to 26 V,	I _O = 10 mA,	T _J = 0°C to 125°C		1	2	mA	
	ENABLE > 2 V					0.5		

[†] Pulse-testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.1- μ F capacitor across the input and a 10- μ F capacitor, with equivalent series resistance of less than 0.4 Ω , across the output.

electrical characteristics, V_I = 14 V, I_O = 10 mA, T_J = 25°C (unless otherwise noted)

PARAMETER		TEST CONDITIONS†		TL750L10 TL751L10			UNIT
				MIN	TYP	MAX	
Output voltage	V _I = 11 V to 26 V,	I _O = 0 to 150 mA	T _J = 25°C	9.6	10	10.4	V
Output voltage	V = 11 V to 26 V,	IQ = 0 to 150 IIIA	$T_J = 0$ °C to 125°C	9.5		10.5	V
Input regulation voltage	V _I = 12 V to 19 V				10	25	mV
Input regulation voltage	V _I = 11 V to 26 V				30	60	IIIV
Ripple rejection	V _I = 12 V to 22 V,	f = 120 Hz		60	65		dB
Output regulation voltage	$I_{O} = 5 \text{ mA to } 150 \text{ mA}$				50	100	mV
Dronout voltage	I _O = 10 mA					0.2	V
Dropout voltage	I _O = 150 mA					0.6	V
Output noise voltage	f = 10 Hz to 100 kHz				700		μV
	I _O = 150 mA				10	12	
Input bias current	V _I = 11 V to 26 V,	$I_{O} = 10 \text{ mA},$	$T_J = 0$ °C to 125°C		1	2	mA
	ENABLE > 2 V					0.5	

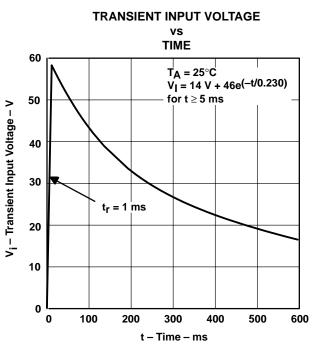
 $[\]overline{1}$ Pulse-testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.1-μF capacitor across the input and a 10-μF capacitor, with equivalent series resistance of less than 0.4 Ω , across the output.

electrical characteristics, $V_I = 14 \text{ V}$, $I_O = 10 \text{ mA}$, $T_J = 25^{\circ}\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS [†]		TL750L12 TL751L12			UNIT
			MIN	TYP	MAX	
Output voltage	$V_1 = 13 \text{ V to } 26 \text{ V}, I_0 = 0 \text{ to } 150 \text{ mA}$	T _J = 25°C	11.52	12	12.48	V
Output voltage	$V_1 = 13 \text{ V to 26 V}, IO = 0 \text{ to 130 IIIA}$	$T_J = 0$ °C to 125°C	11.4		12.6	V
Input regulation voltage	V _I = 14 V to 19 V			15	30	mV
Input regulation voltage	V _I = 13 V to 26 V			20	40	IIIV
Ripple rejection	V _I = 13 V to 23 V, f = 120 Hz			55		dB
Output regulation voltage	$I_O = 5 \text{ mA to } 150 \text{ mA}$			50	120	mV
Dropout voltage	$I_O = 10 \text{ mA}$				0.2	V
Dropout voltage	I _O = 150 mA				0.6	V
Output noise voltage	f = 10 Hz to 100 kHz			700		μV
	I _O = 150 mA			10	12	
Input bias current	$V_I = 13 \text{ V to } 26 \text{ V}, I_O = 10 \text{ mA},$	$T_J = 0$ °C to 125°C		1	2	mA
	ENABLE > 2 V				0.5	

[†] Pulse-testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.1- μ F capacitor across the input and a 10- μ F capacitor, with equivalent series resistance of less than 0.4 Ω , across the output.

TYPICAL CHARACTERISTICS



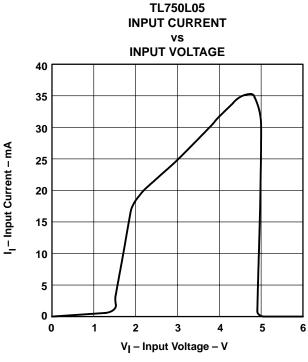
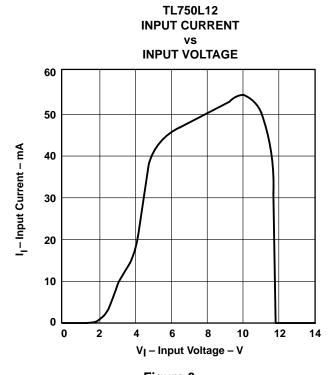


Figure 1

Figure 2





TYPICAL CHARACTERISTICS

TL750L05 EQUIVALENT SERIES RESISTANCE

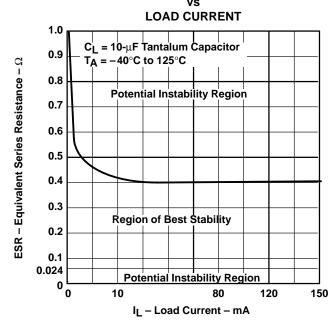
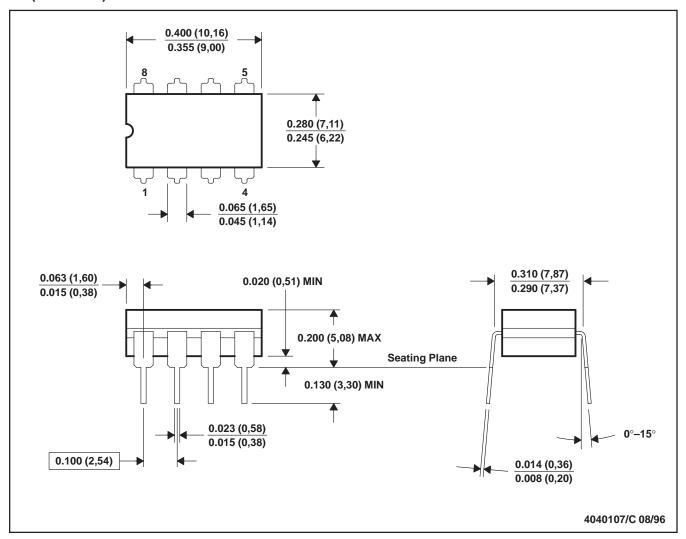


Figure 4

JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

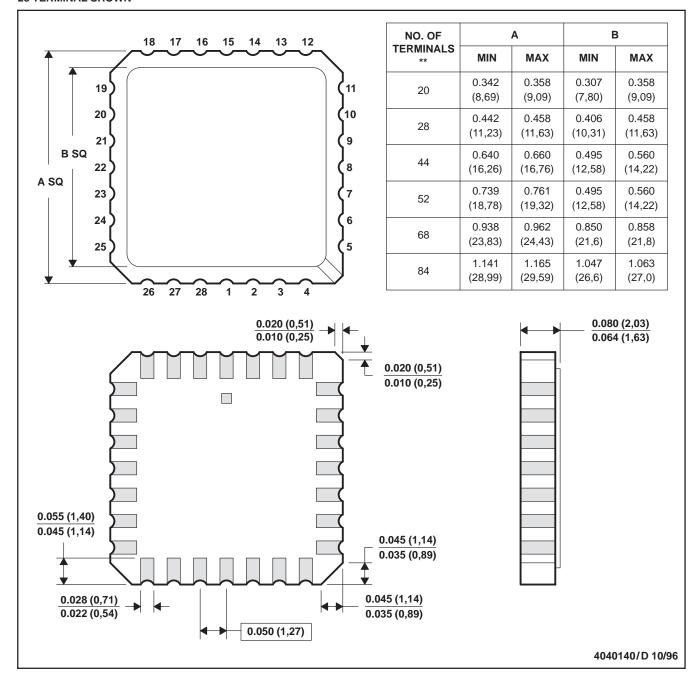
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8

1

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



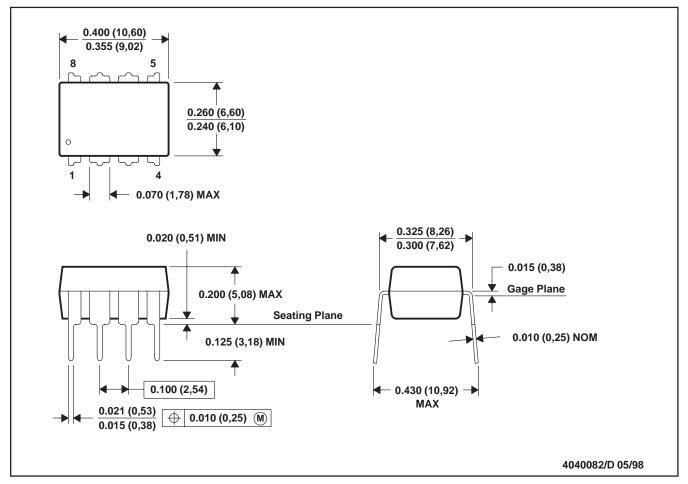
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



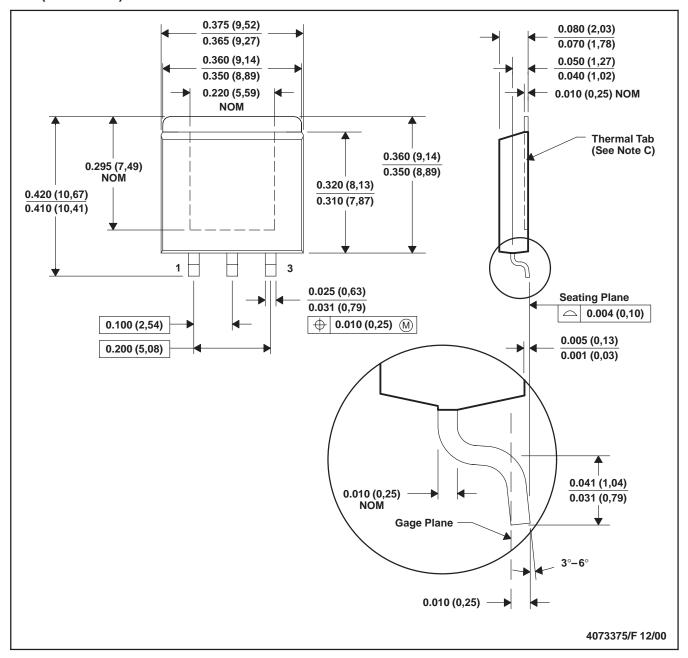
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm

KTE (R-PSFM-G3)

PowerFLEX™ PLASTIC FLANGE-MOUNT



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. The center lead is in electrical contact with the thermal tab.
- D. Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).
- E. Falls within JEDEC MO-169

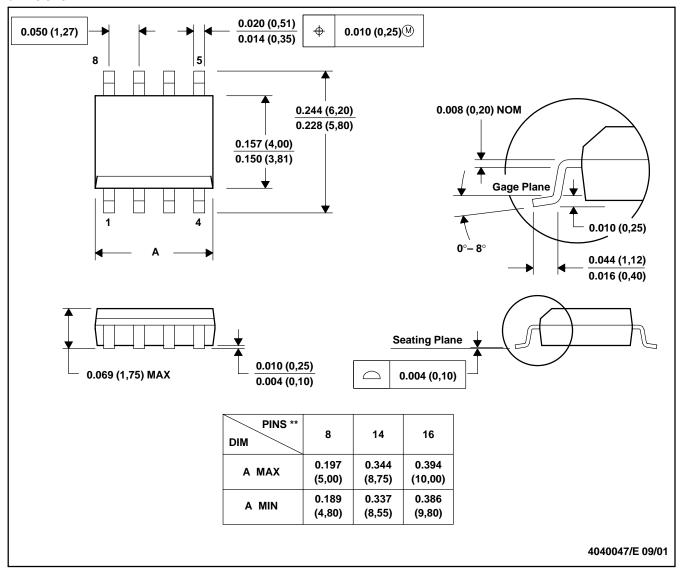
PowerFLEX is a trademark of Texas Instruments.



D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

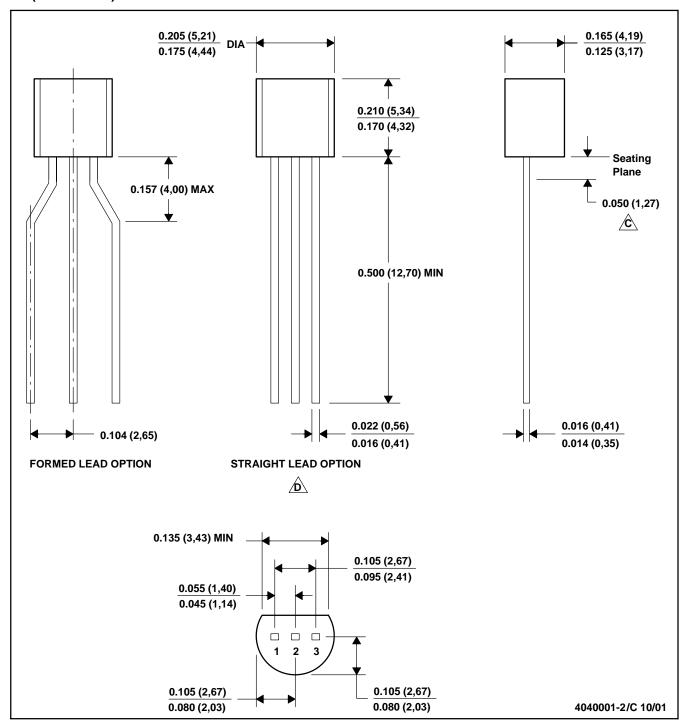
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C.\ Lead dimensions are not controlled within this area

√D.\ FAlls within JEDEC TO -226 Variation AA (TO-226 replaces TO-92)

E. Shipping Method:

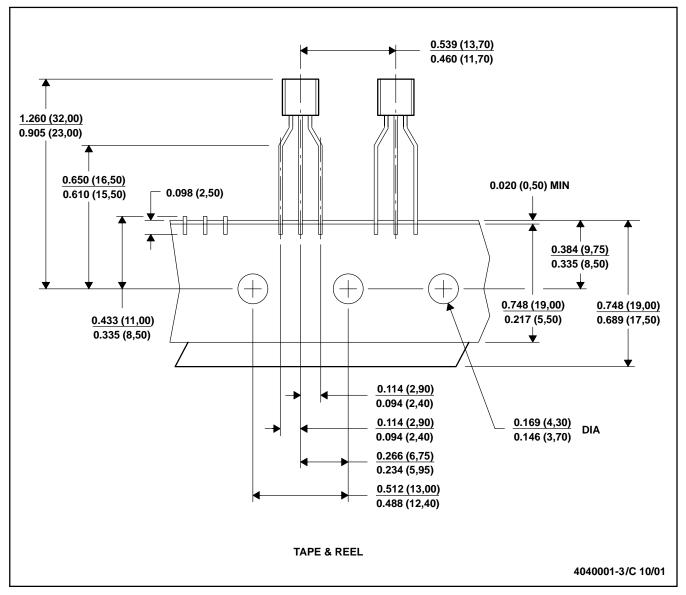
Straight lead option available in bulk pack only.

Formed lead option available in tape & reel or ammo pack.



LP (O-PBCY-W3)

PLASTIC CYLINDRICAL PACKAGE



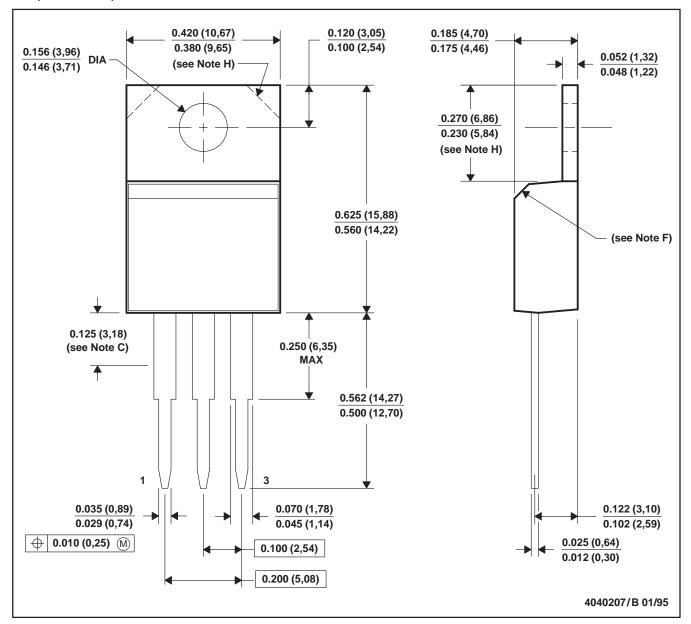
NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Tape and Reel information for the Format Lead Option package.

KC (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Lead dimensions are not controlled within this area.
- D. All lead dimensions apply before solder dip.
- E. The center lead is in electrical contact with the mounting tab.
- F. The chamfer is optional.
- G. Falls within JEDEC TO-220AB
- H. Tab contour optional within these dimensions



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